



General description

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a DFN1006(SOD882) leadless ultra small Surface-Mounted Device (SMD) plastic package designed to protect one signal line from the damage caused by ESD and other transients.

Features and benefits

- Bidirectional ESD protection of one line
- Low operating voltage: 7.0V
- Low clamping voltage $V_C = 13 \text{ V@8A}$
- Response time is typically $< 1 \text{ ns}$
- Ultra Low Leakage: nA Level
- IEC 61000-4-2; level 4 (ESD)
- IEC 61000-4-5 (surge); $I_{PPM} = 8 \text{ A}$

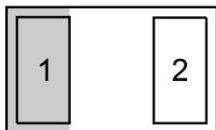
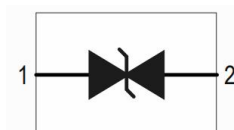
Application information

- Portable electronics
- Computers and peripherals
- Audio and video equipment
- Cellular handsets and accessories
- Communication systems
- Power supplies

Ordering information

Device	Package	Packaging	Reel Size
SLESD8E7.0C	DFN1006-2L	10000/Tape & Reel	7 Inch

Schematic & Pin configuration

Simplified outline	Graphic symbol
	

Maximum Ratings ($T_{OP} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

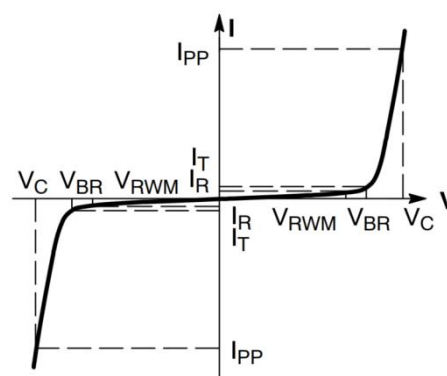
Parameter	Symbol	Value	Unit
Peak Pulse Power ($T_p = 8/20\text{ }\mu\text{s}$)	P_{PPM}	104	W
Rated Peak Pulse Current ($T_p = 8/20\text{ }\mu\text{s}$)	I_{PPM}	8	A
Maximum lead temperature for soldering during 10s	T_L	260	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^{\circ}\text{C}$
Operating Temperature Range	T_{OP}	-40 to +125	$^{\circ}\text{C}$
Maximum junction temperature	T_j	150	$^{\circ}\text{C}$
ESD voltage IEC 61000-4-2 (air discharge)	V_{ESD}	30	kV
ESD voltage IEC 61000-4-2 (contact discharge)	V_{ESD}	30	kV

Electrical Characteristics ($T_{OP} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

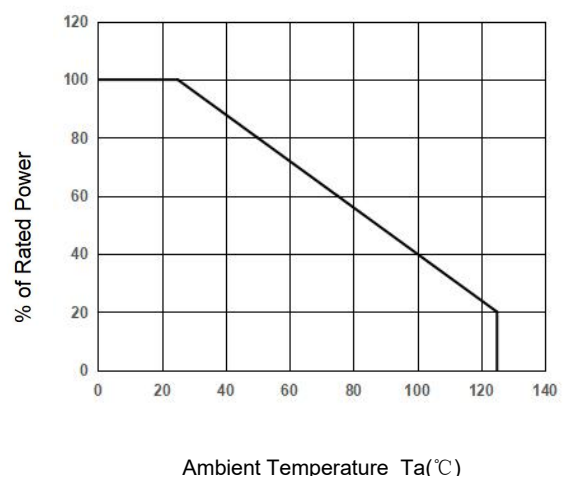
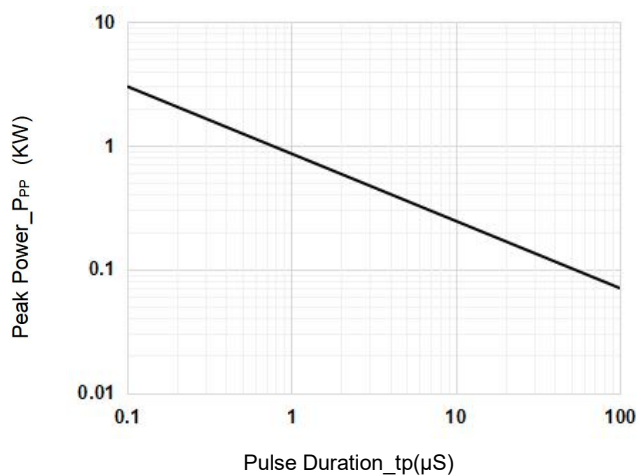
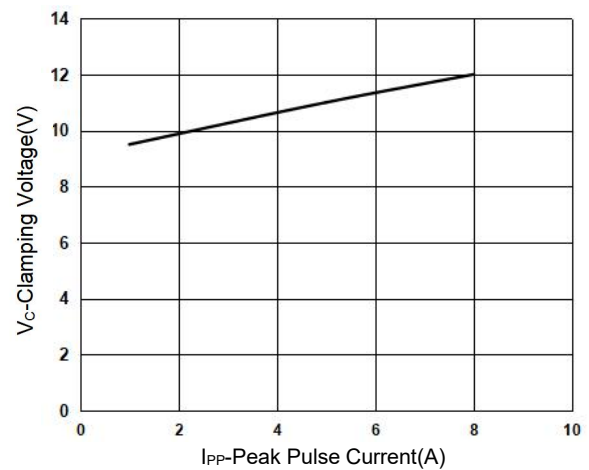
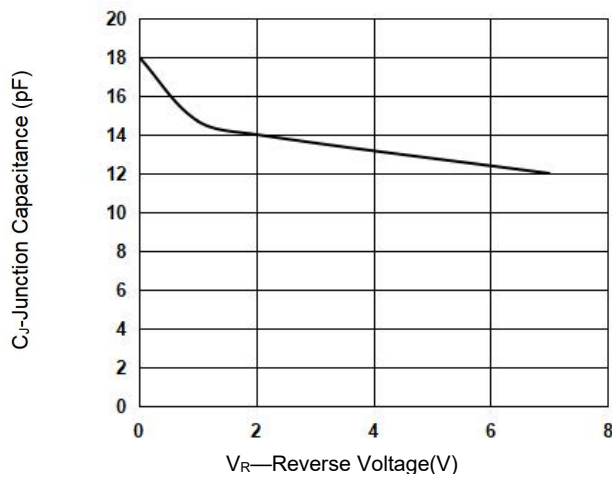
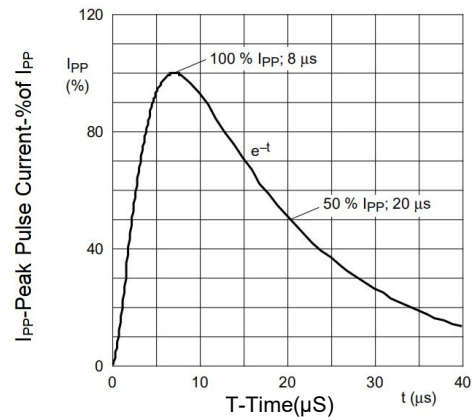
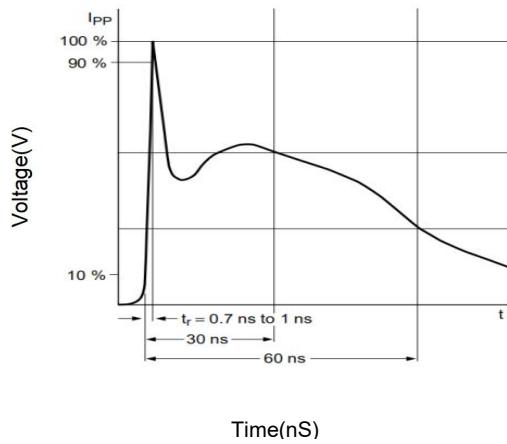
Parameter	Symbol	Min	Typ	Max	Unit	Condition
Reverse Working Voltage	V_{RWM}	--	--	7.0	V	
Breakdown Voltage	V_{BR}	7.6	8.2	9.0	V	$I_T = 1\text{mA}$
Leakage Current I_{Leak}	I_R	--	--	0.1	μA	$V_{RWM} = 7.0\text{V}$
Clamping Voltage	V_C	--	10.0	12.0	V	$I_{pp} = 5\text{A}, T_p = 8/20\mu\text{s}$
Clamping Voltage	V_C	--	11.5	13.0	V	$I_{pp} = 8\text{A}, T_p = 8/20\mu\text{s}$
Junction Capacitance	C_j	--	18.0	25.0	pF	$V_R = 0\text{V}, f = 1\text{MHz}$

Portion Electronics Parameter

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
I_T	Test Current
V_{BR}	VBR Breakdown Voltage @ I_T

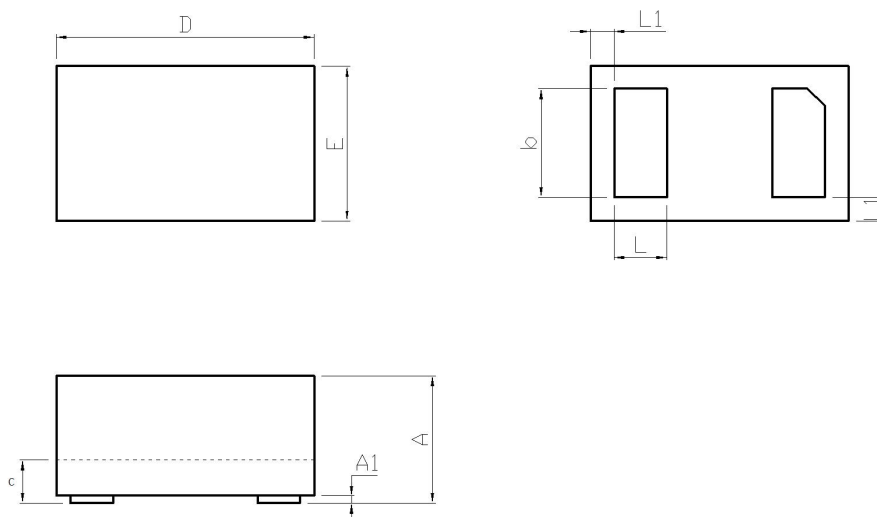


Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise Specified)



Package Outline Dimensions

DFN1006-2L



DFN1006-2L (mm)			
Dim	Min	Typ.	Max
A	0.45	0.50	0.55
A1	0	0.02	0.05
b	0.45	0.5	0.55
c	0.1	0.15	0.18
D	0.95	1.00	1.05
E	0.55	0.60	0.65
L	0.20	0.25	0.30
L1	0.035	0.05	0.065